MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

WQFN25 6x5, 0.65P
CASE 510BQ
ISSUE 0

DATE 31 JUL 2016

NOTE:
A) DIMENSIONS ARE IN MILLIMETERS.
B) DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
D) DESIGN BASED ON JEDEC MO-220 VARIATION WJHC
E) TERMINALS ARE SYMMETRICAL AROUND THE X & Y AXIS EXCEPT WHERE DEPLOPULATED.

NOTES: UNLESS OTHERWISE SPECIFIED

OPTIONAL LEAD DESIGN
(LEADS# 1, 24 & 25 ONLY)
SCALE: 1.5X

LEAD CORNER CHAMFER

NOTES:

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